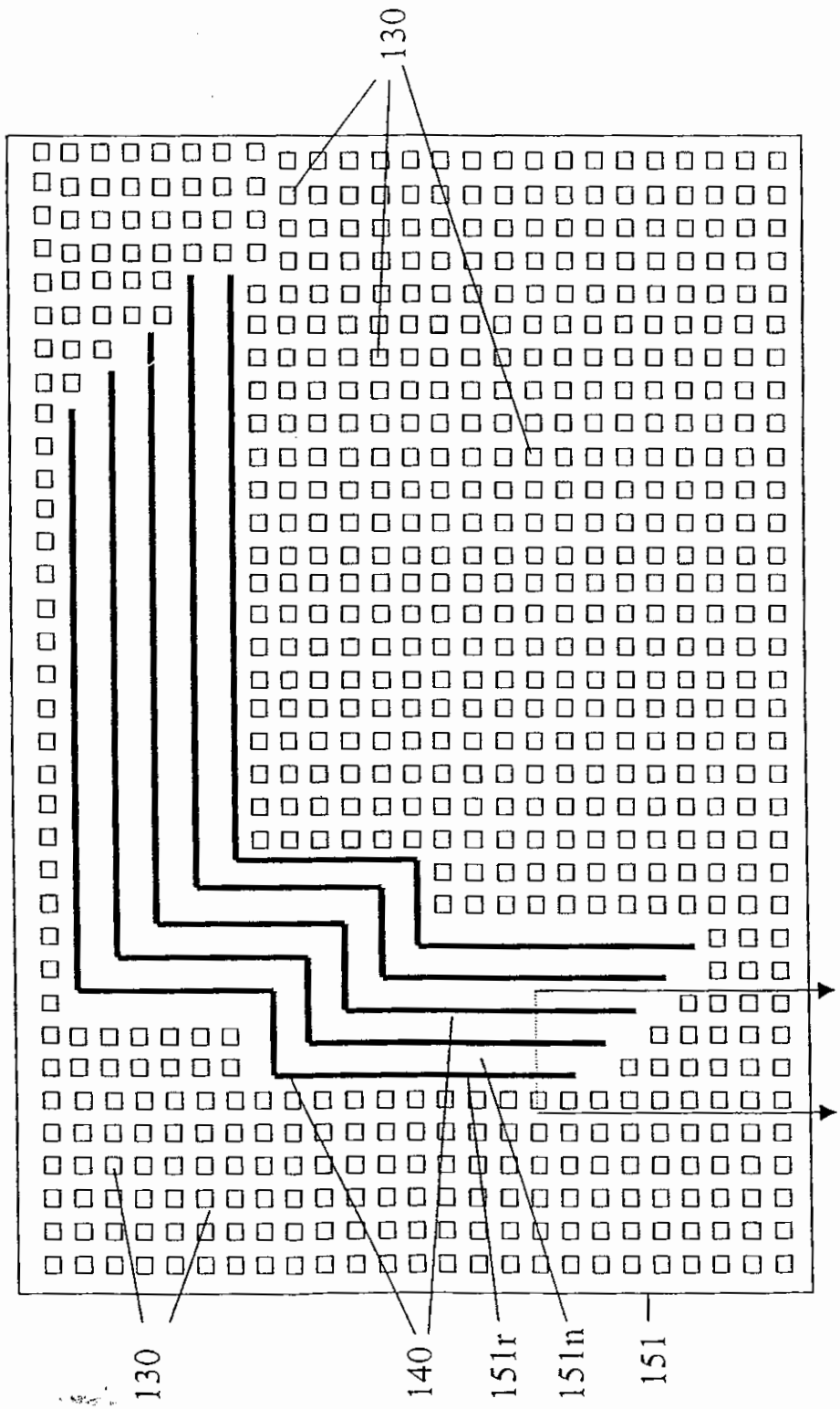


Fig. 1A

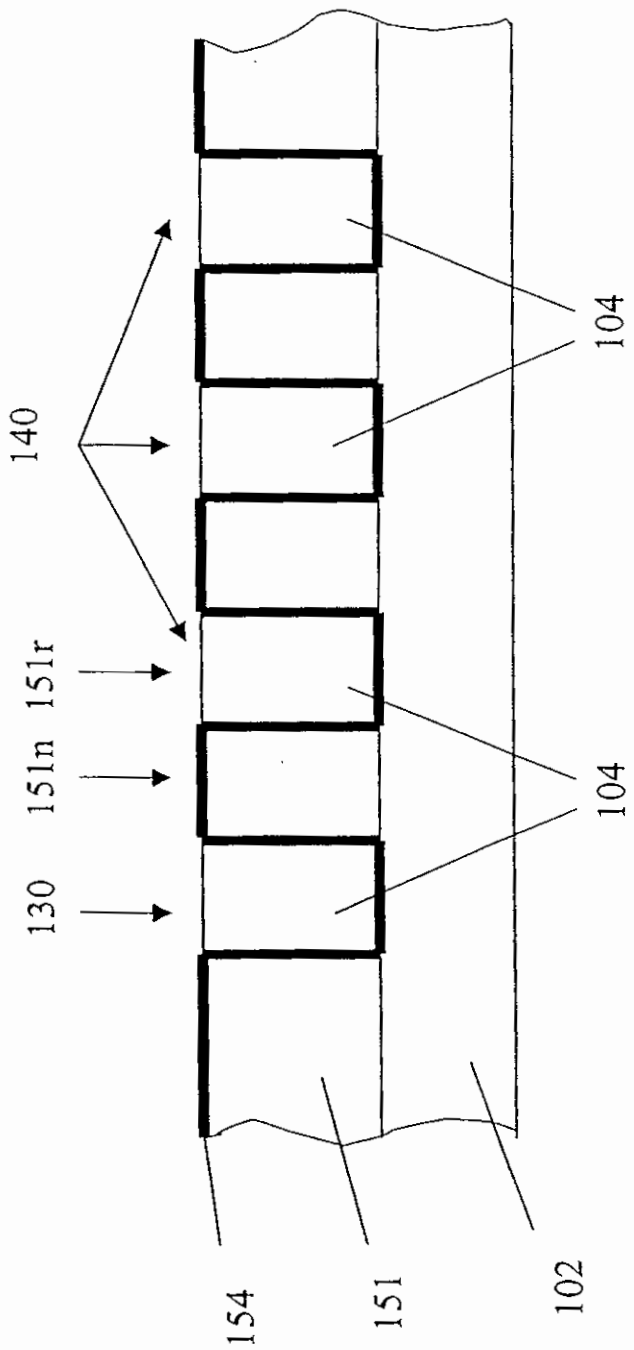


Fig. 1B

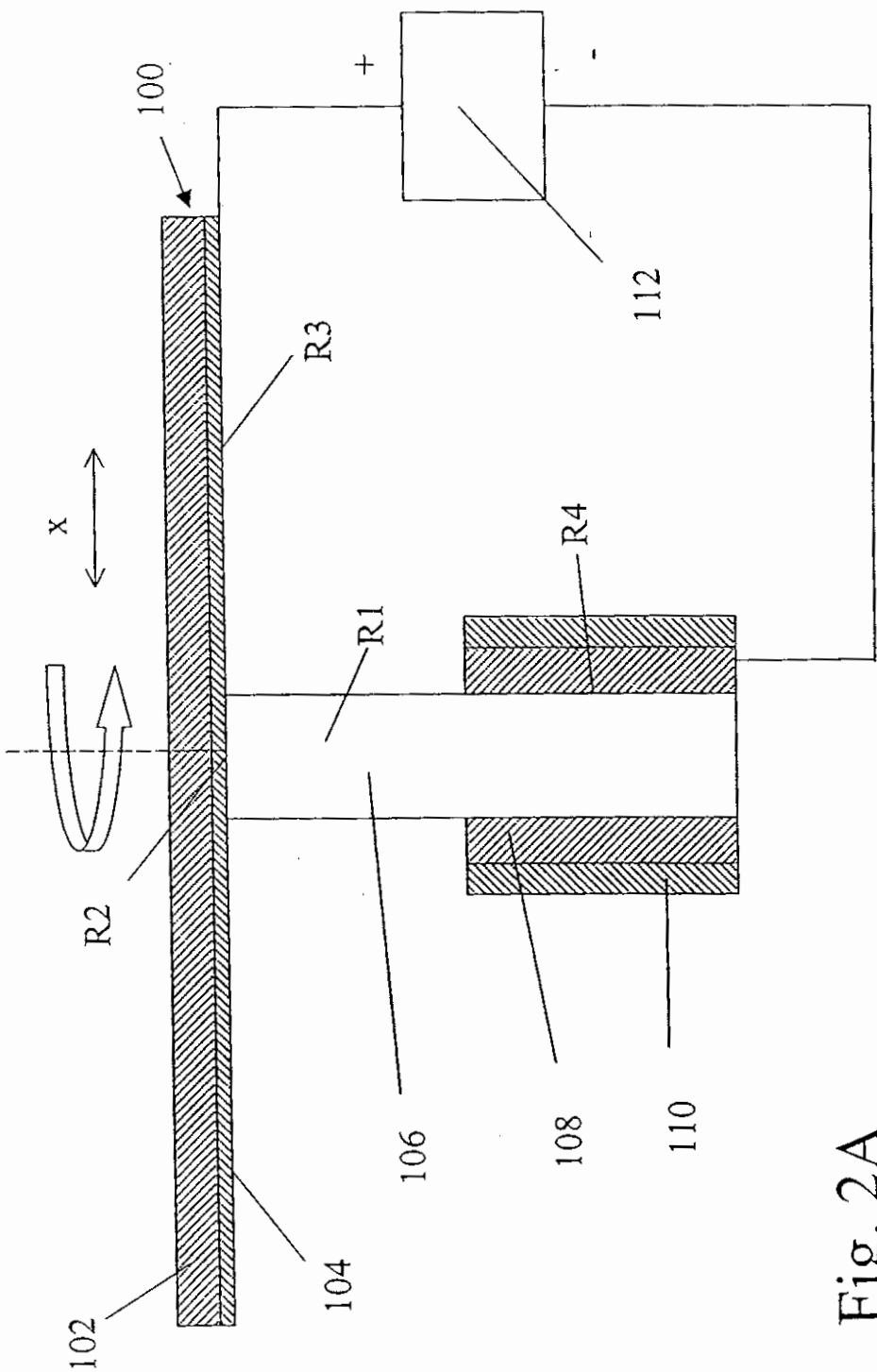


Fig. 2A

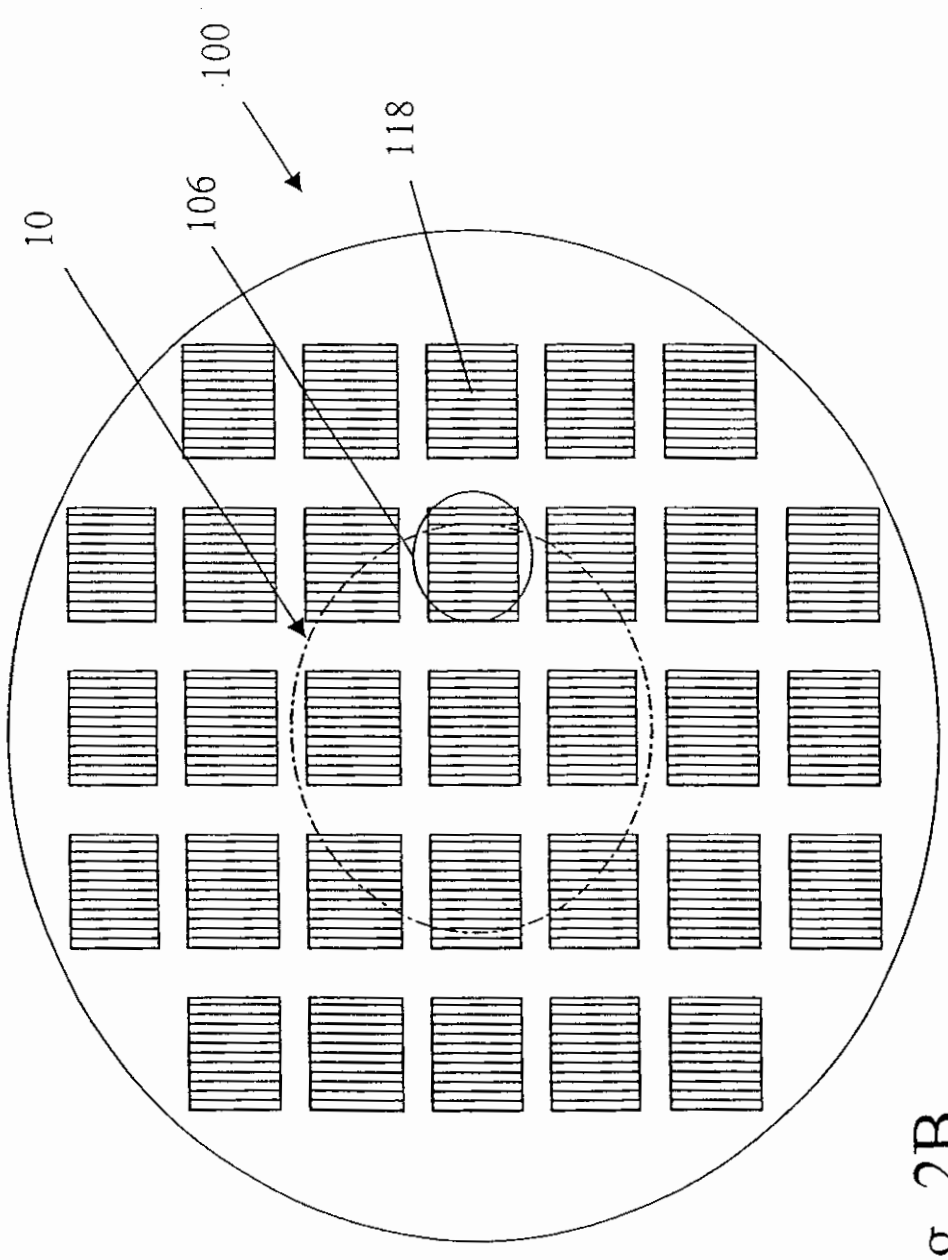


Fig. 2B

Fig. 3A

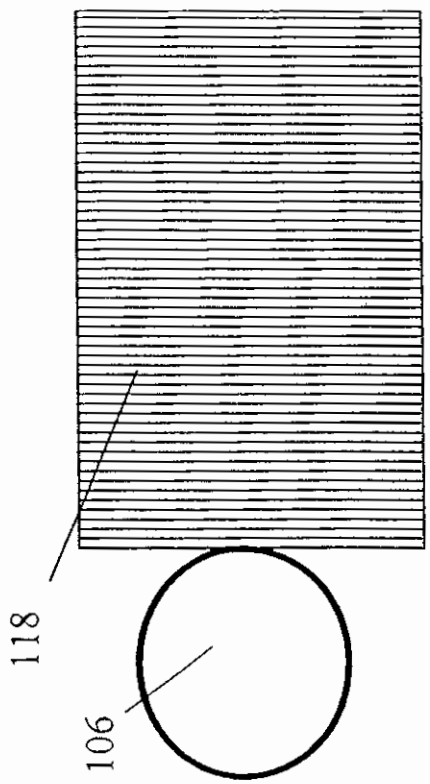


Fig. 3B

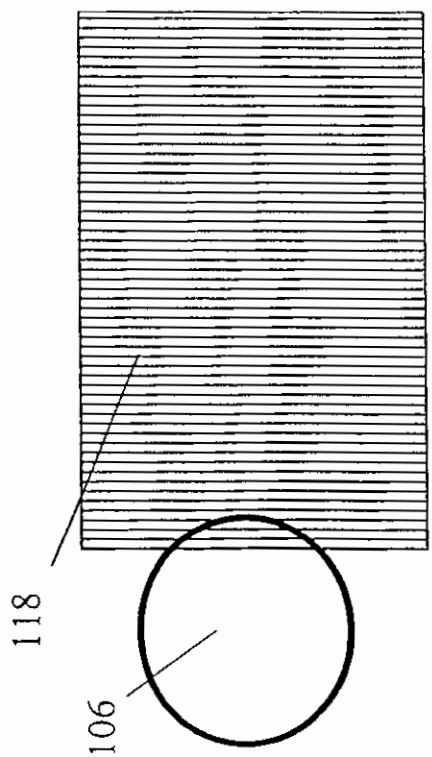


Fig. 3C

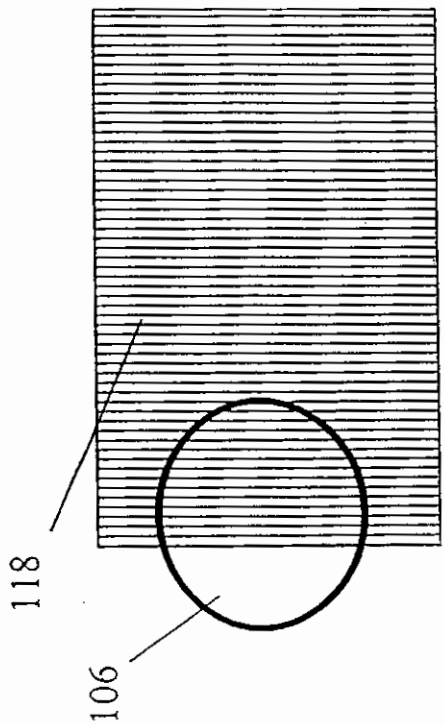
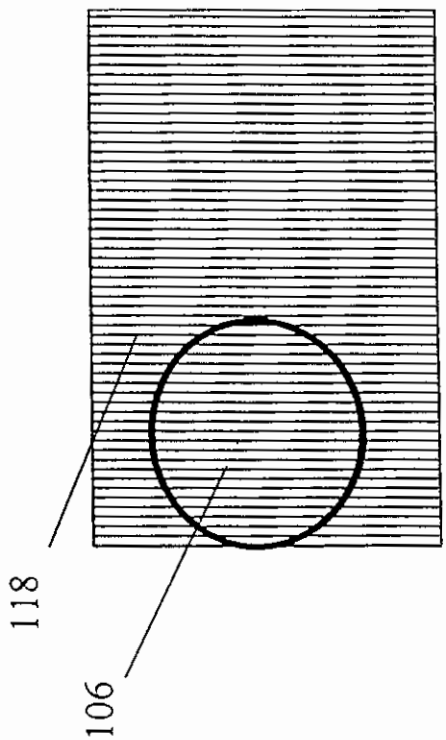


Fig. 3D



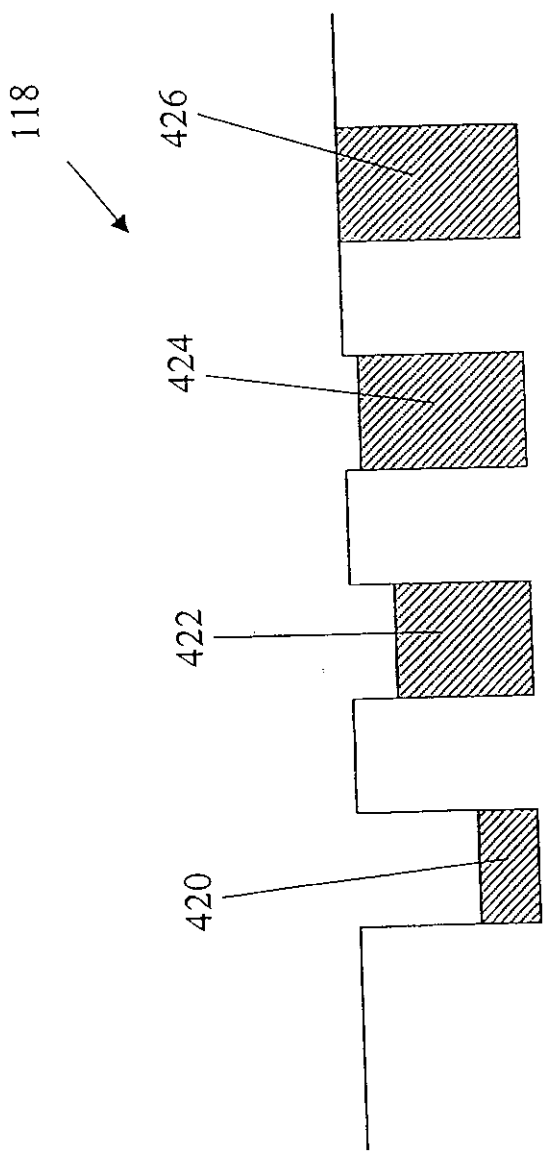


Fig. 4A

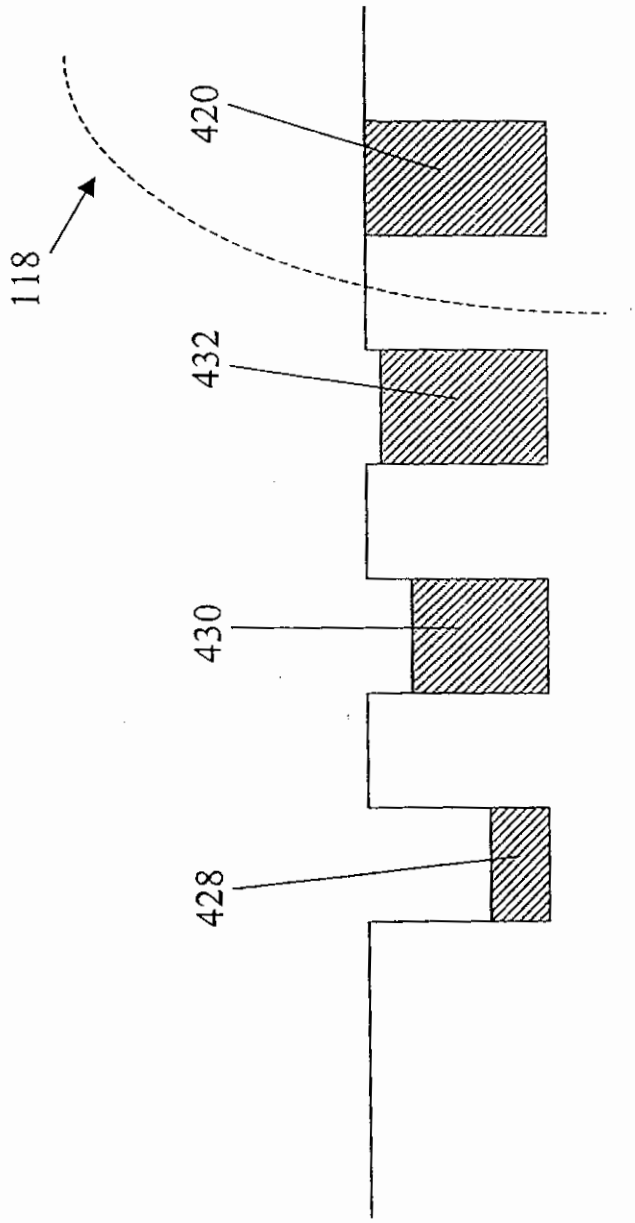


Fig. 4B

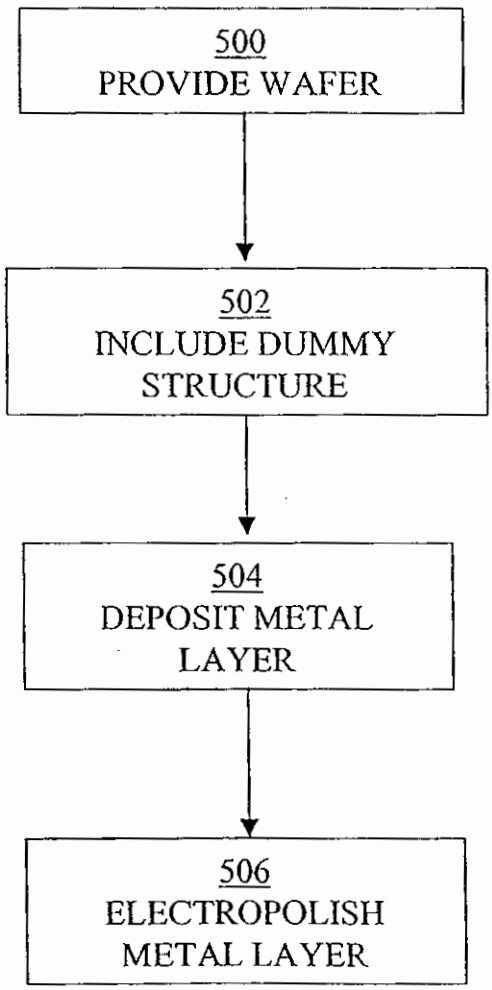

500
PROVIDE WAFER
502
INCLUDE DUMMY STRUCTURE
504
DEPOSIT METAL LAYER
506
ELECTROPOLISH METAL LAYER

Fig. 5

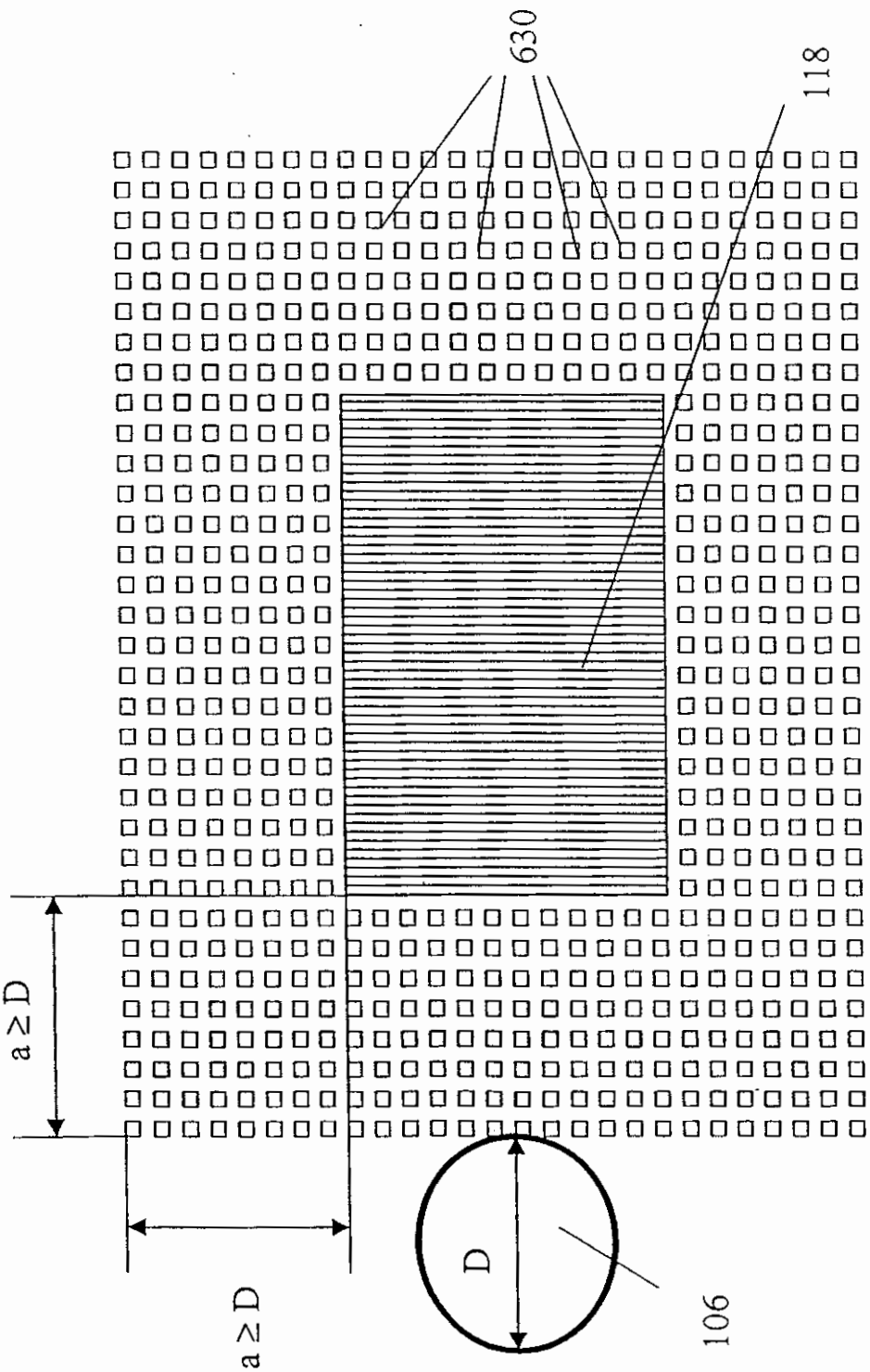


Fig. 6

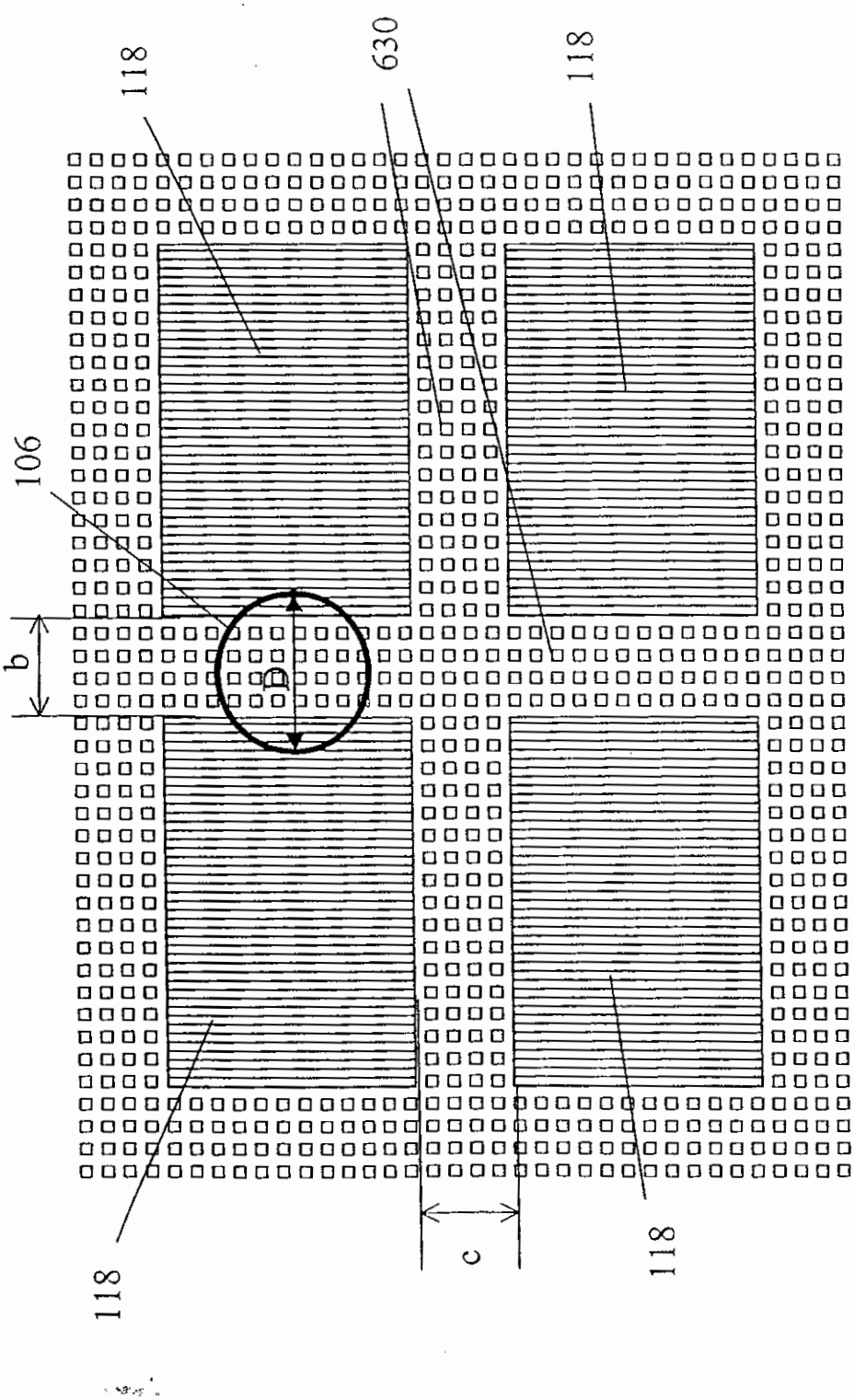


Fig. 7

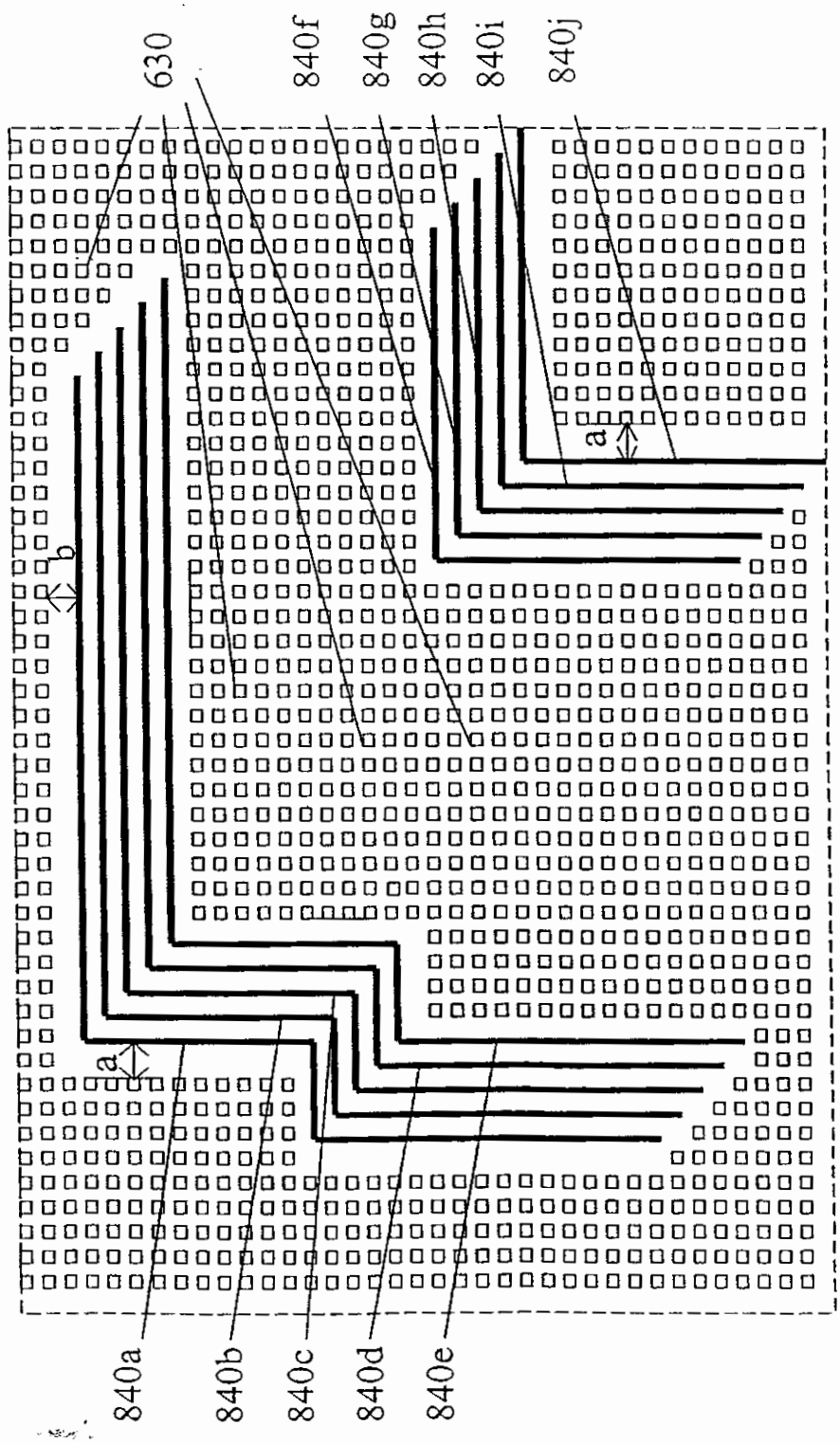


Fig. 8

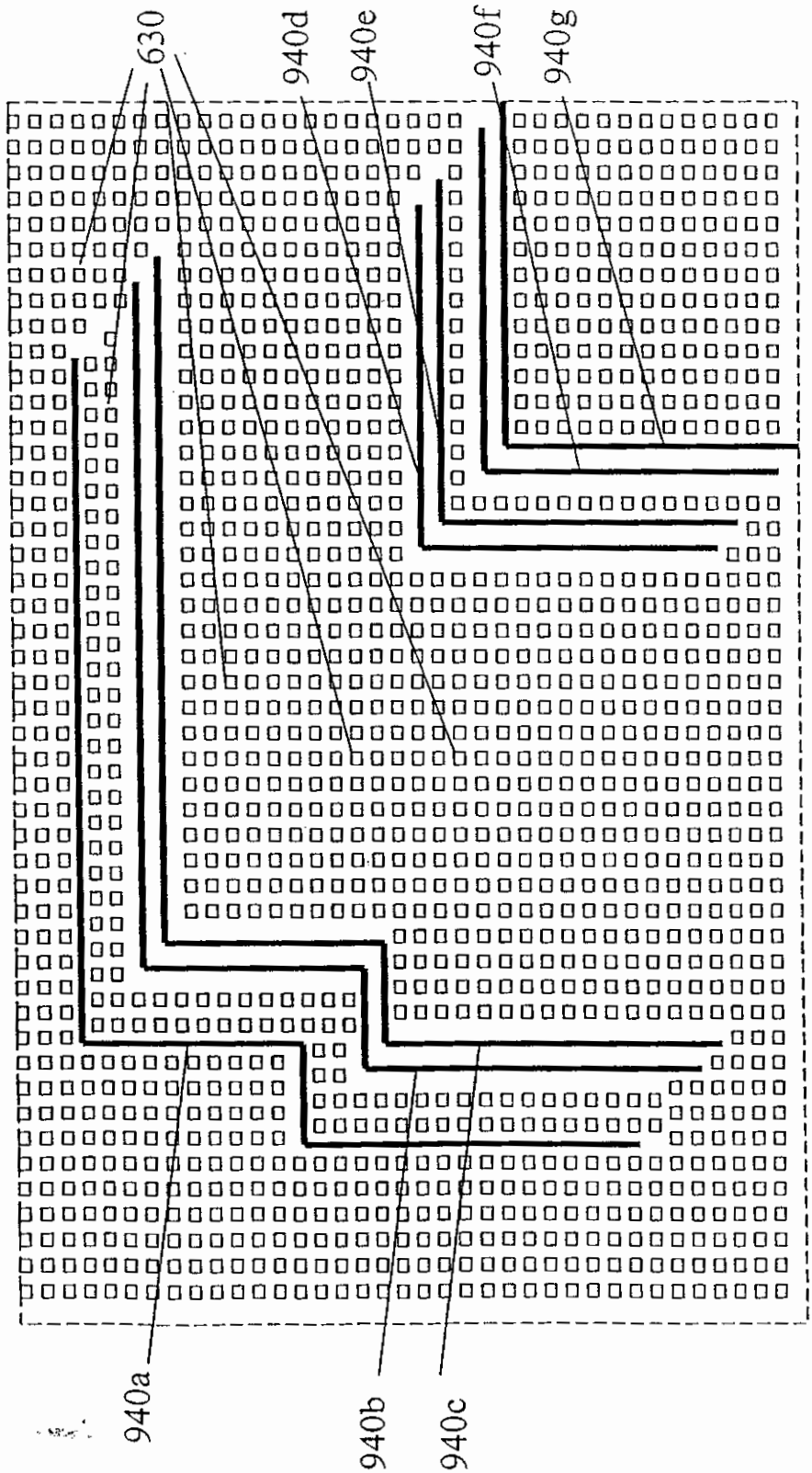


Fig. 9

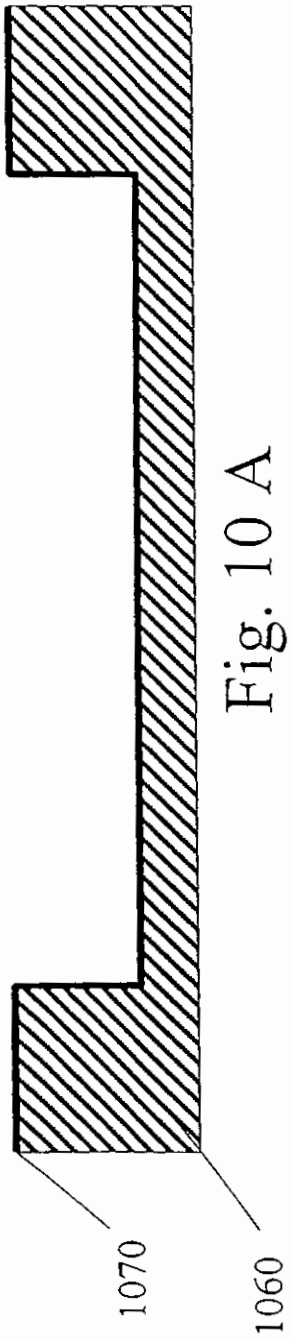


Fig. 10 A

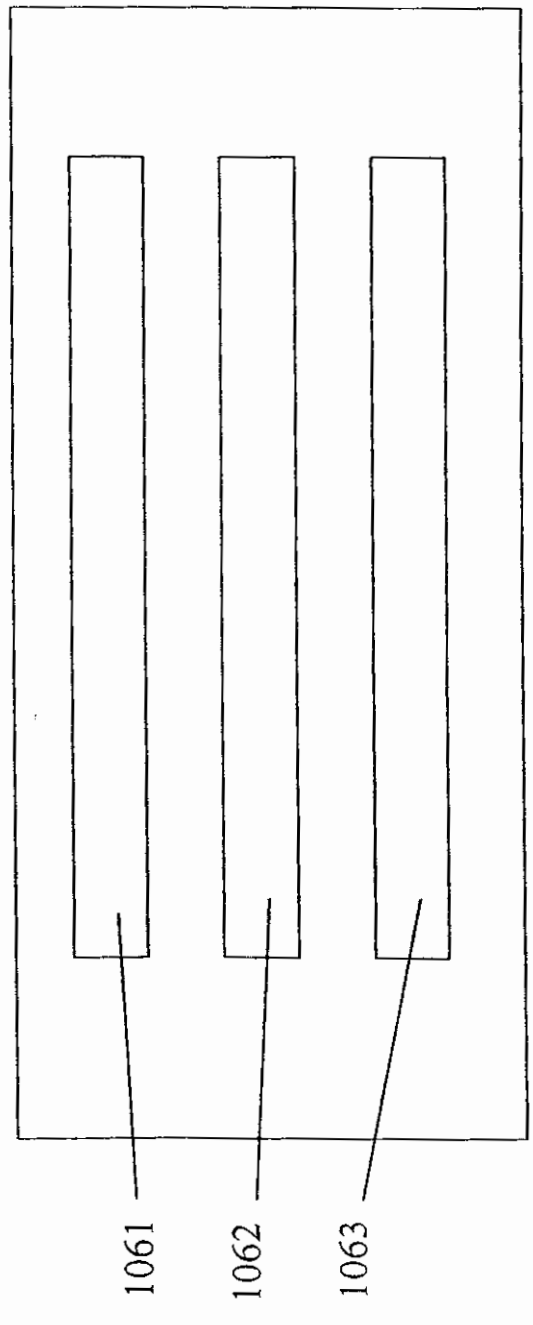


Fig. 10 B

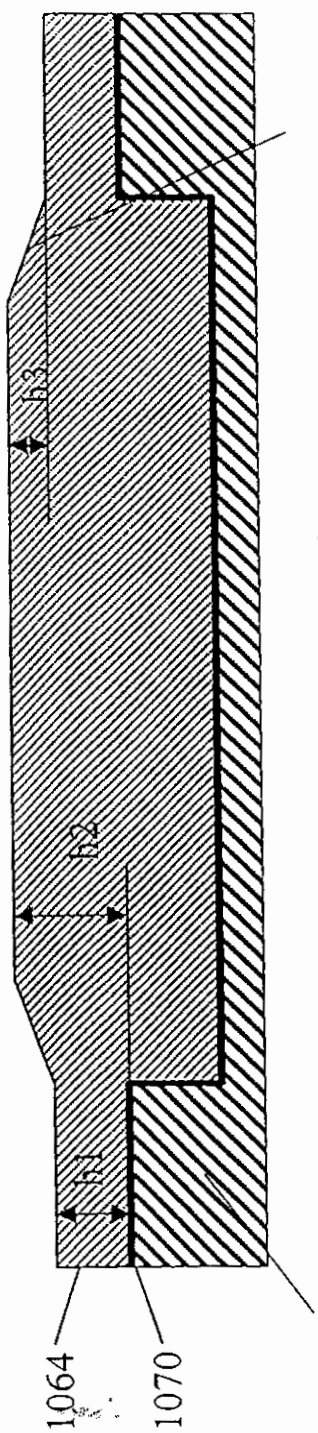


Fig. 10 C

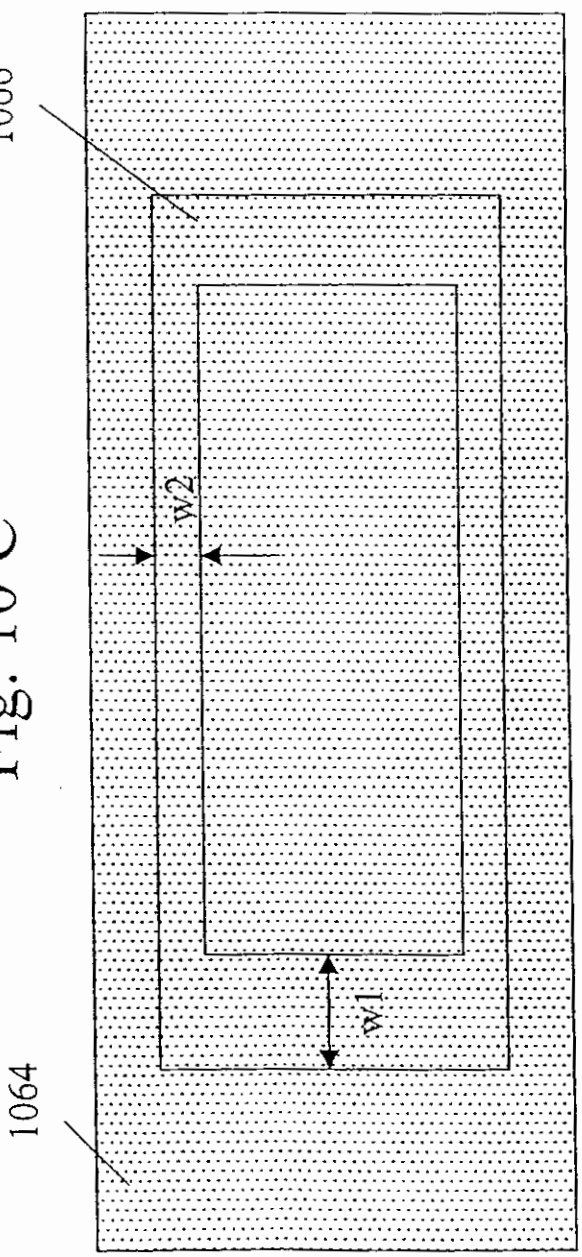


Fig. 10 D

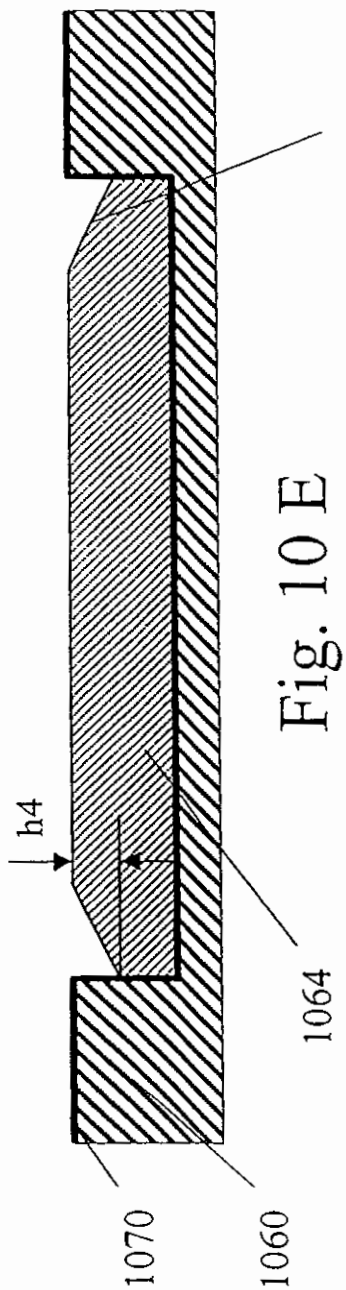


Fig. 10 E

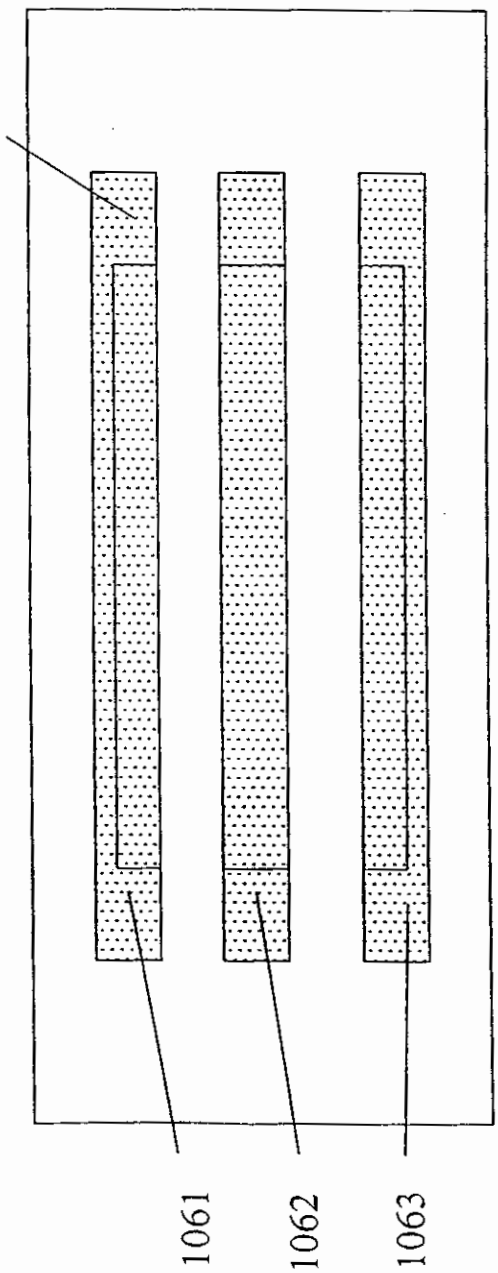


Fig. 10 F

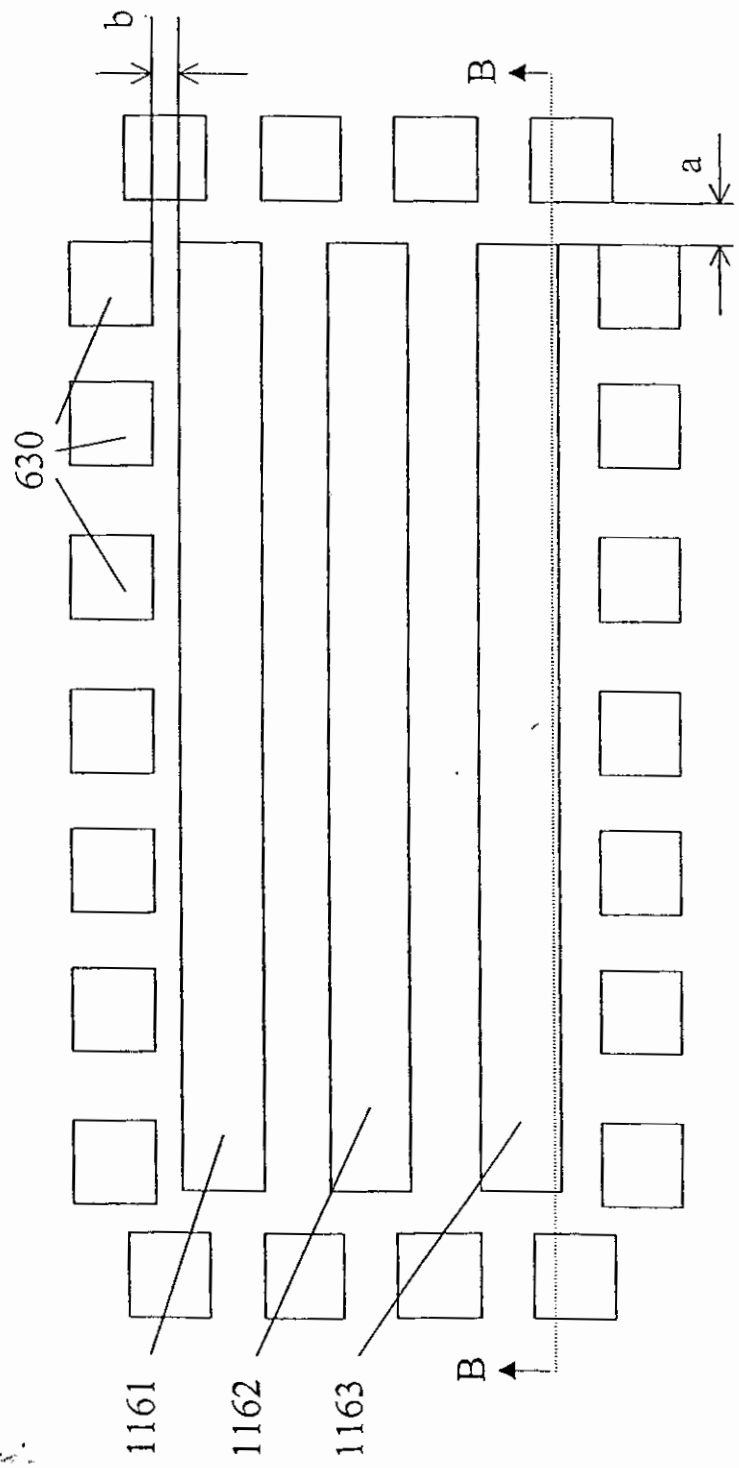


Fig. 11A

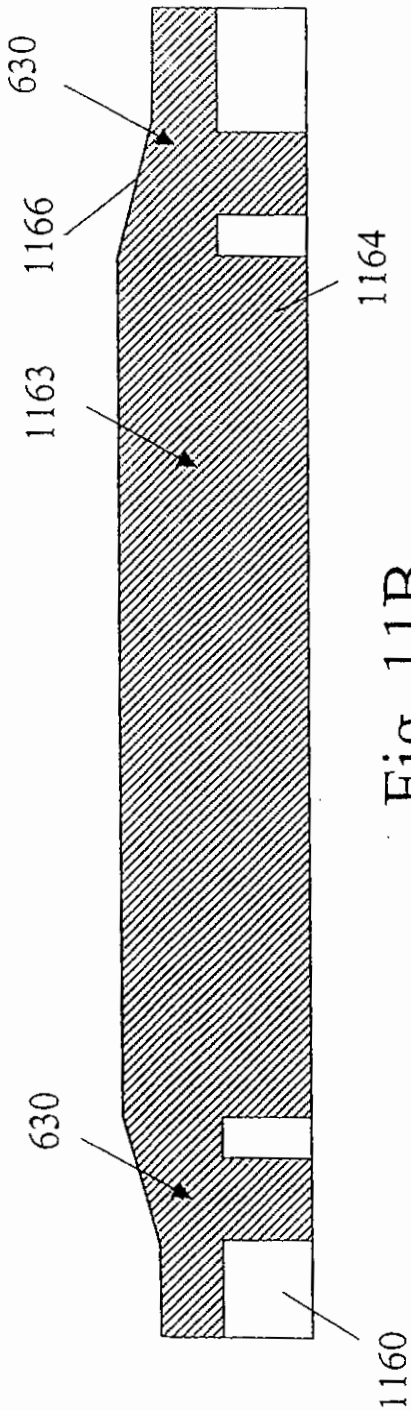


Fig. 11B

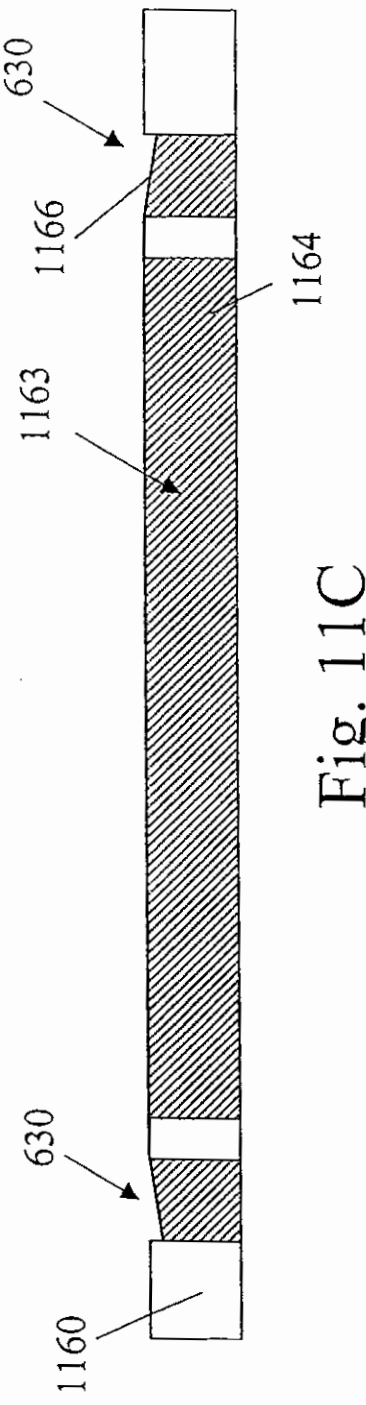


Fig. 11C

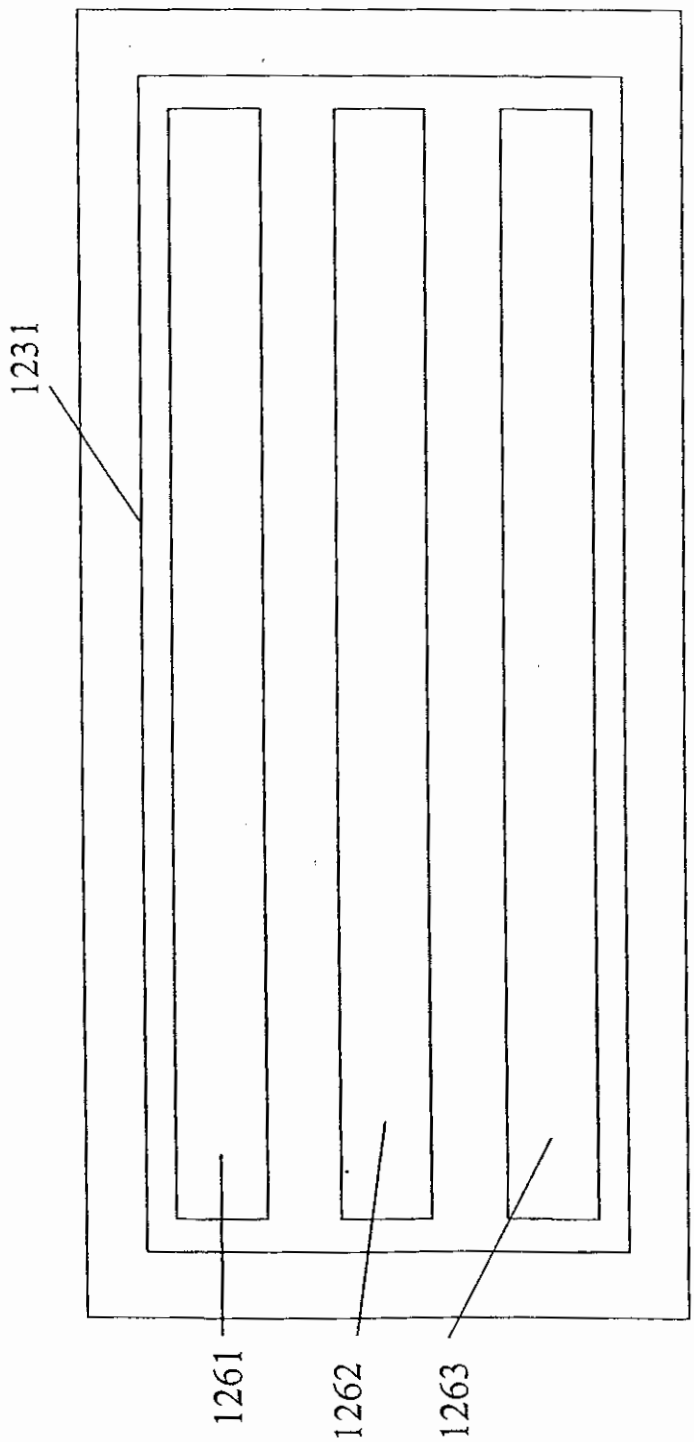


Fig. 12

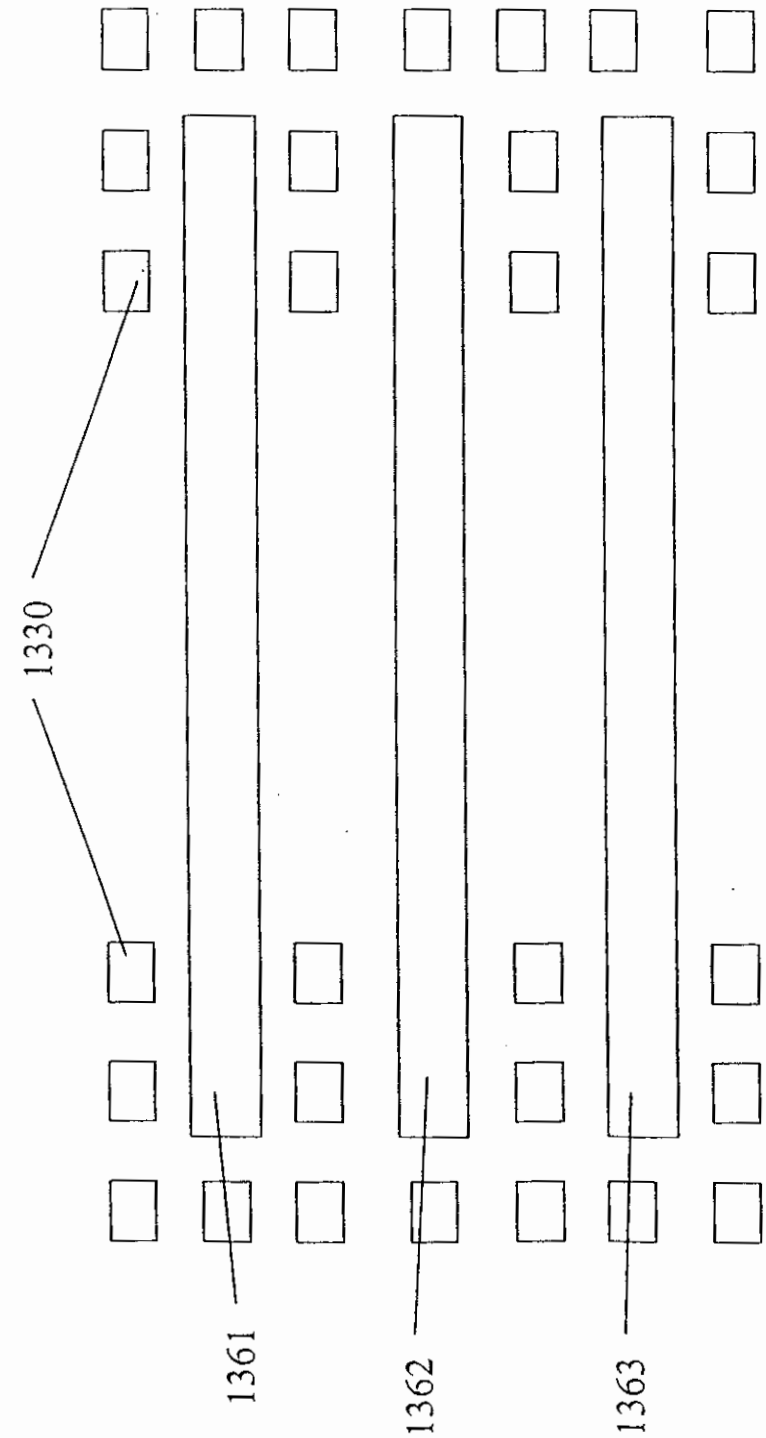


Fig. 13

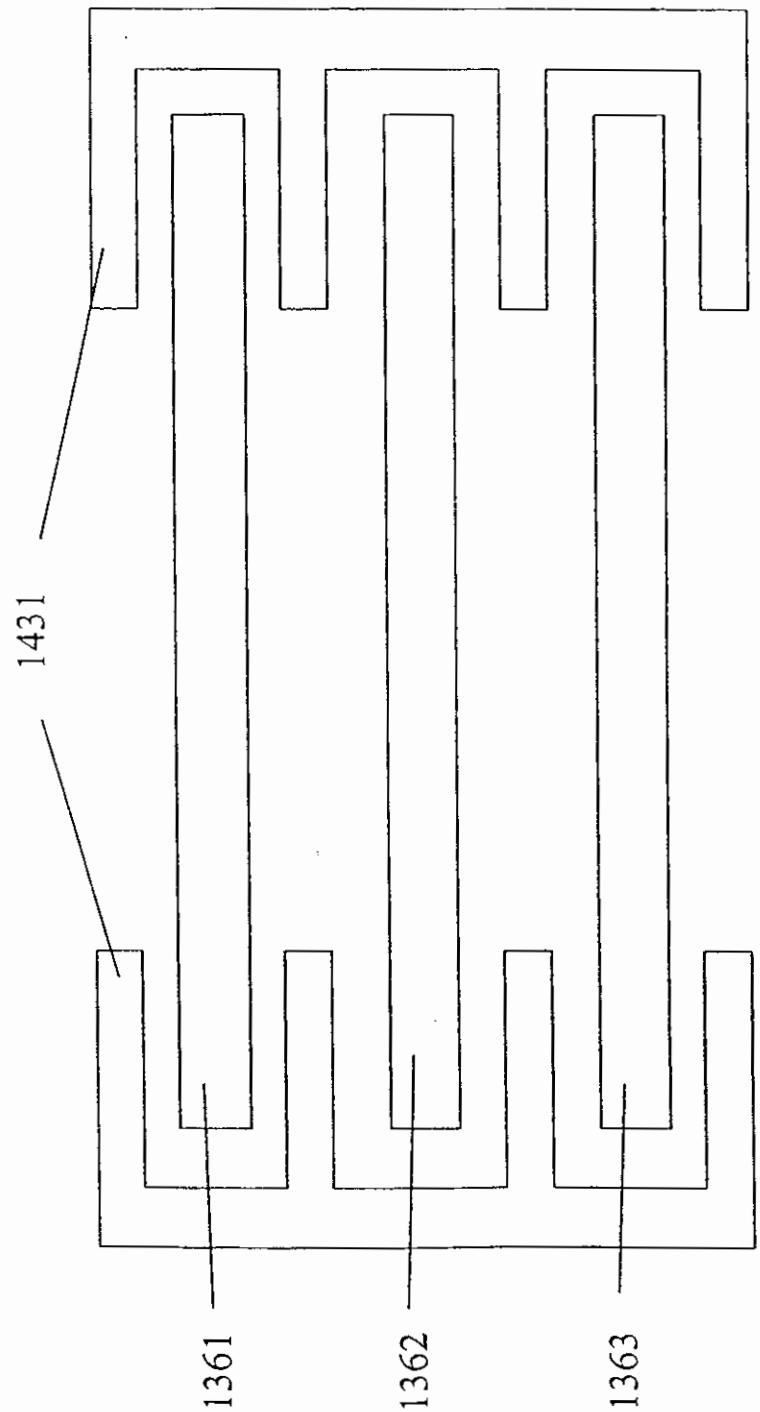


Fig. 14

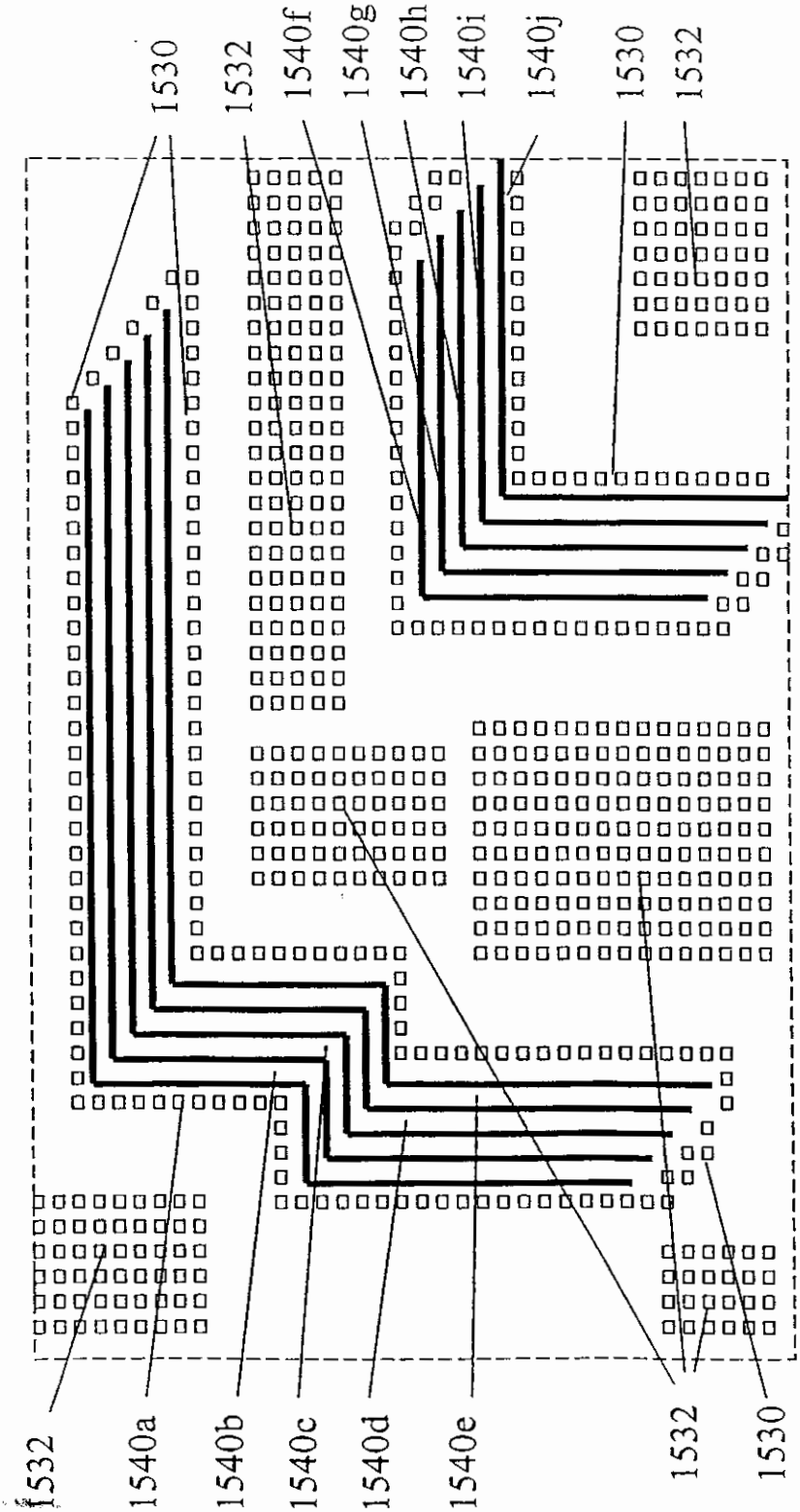

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Fig. 15

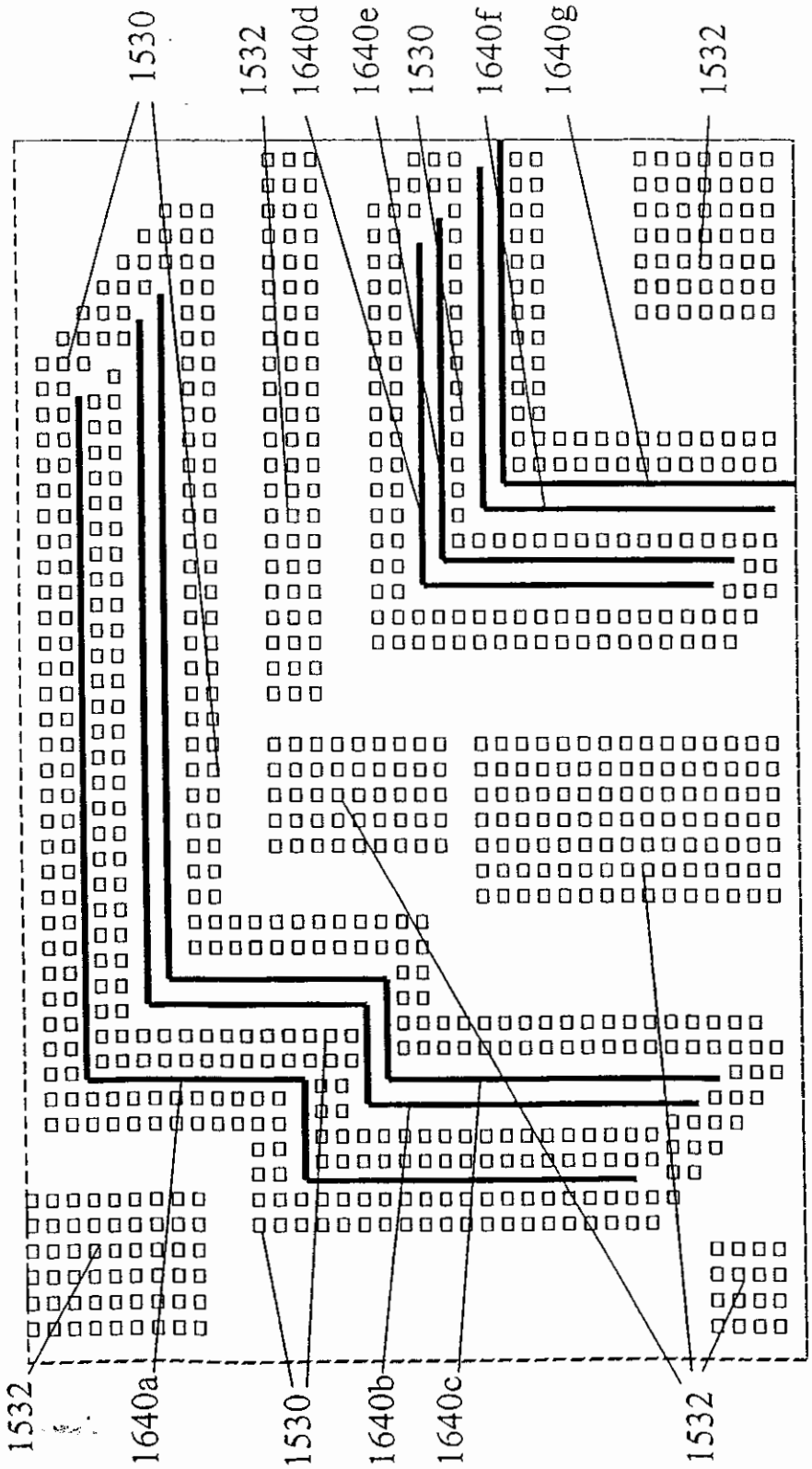

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Fig. 16

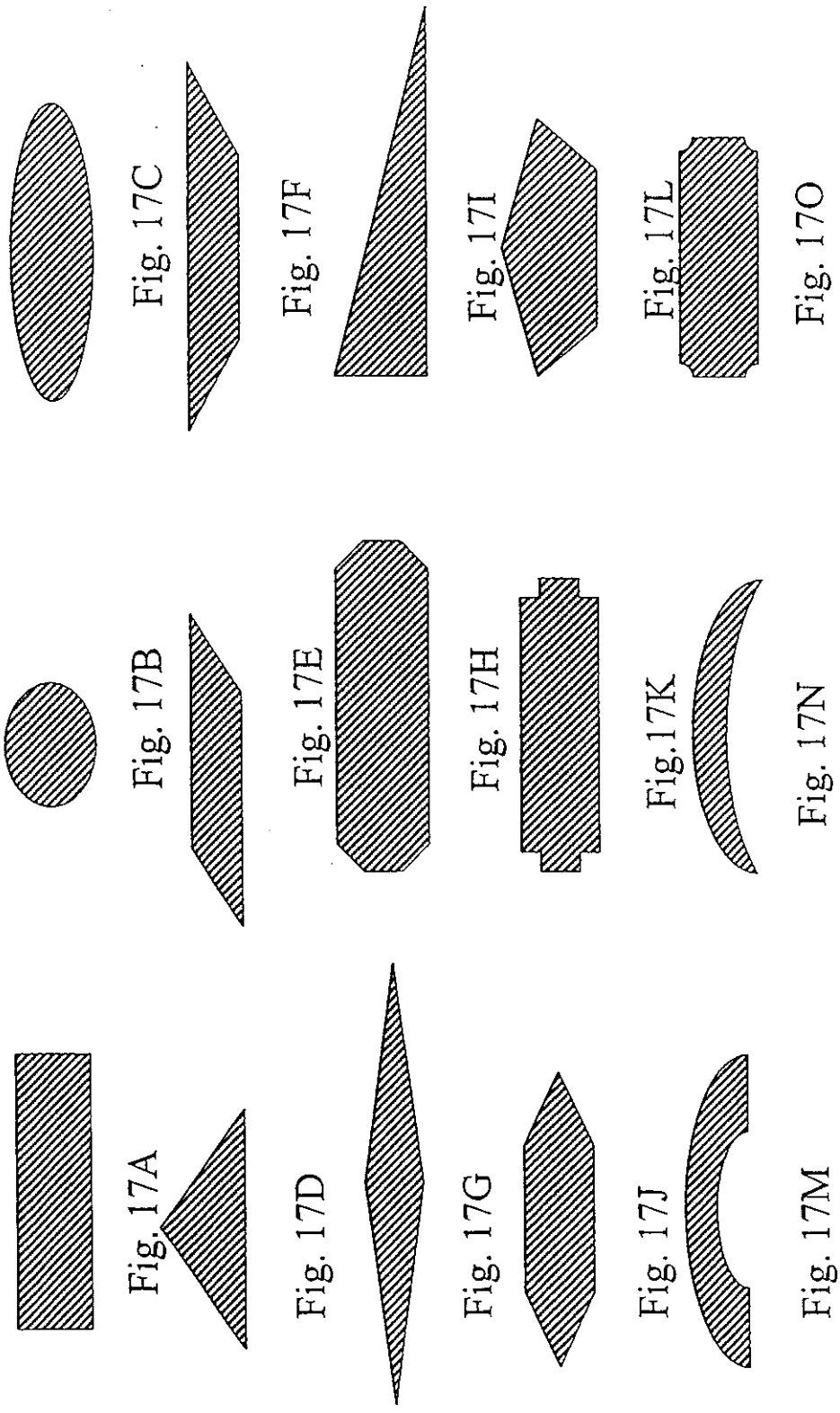


Fig. 17A Fig. 17B Fig. 17C

Fig. 17D Fig. 17E Fig. 17F

Fig. 17G Fig. 17H Fig. 17I

Fig. 17J Fig.17K Fig. 17L

Fig. 17M Fig. 17N Fig. 17O

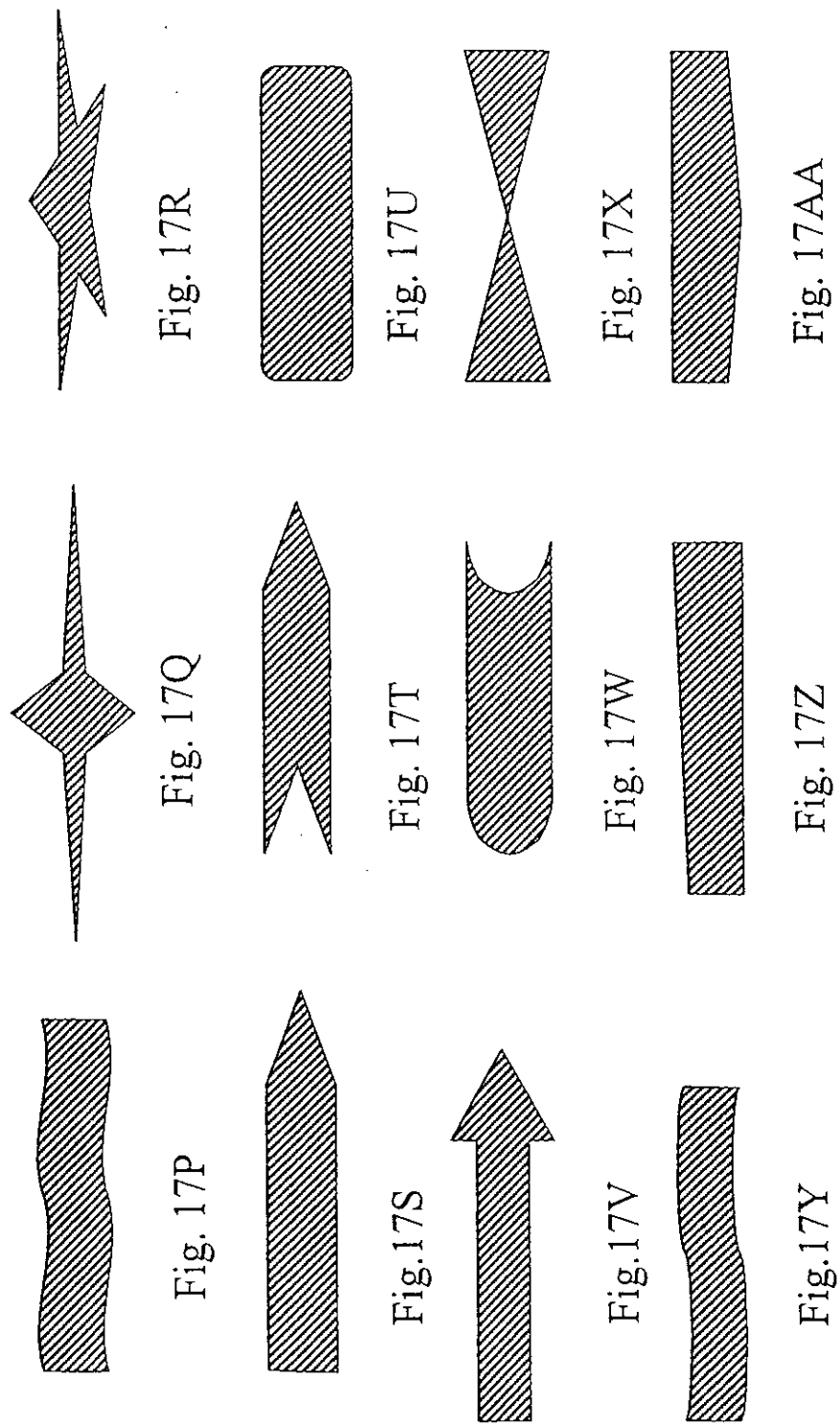


Fig. 17R Fig. 17U Fig. 17X Fig. 17AA

Fig. 17Q Fig. 17T Fig. 17W Fig. 17Z

Fig. 17P Fig.17S Fig.17V Fig.17Y